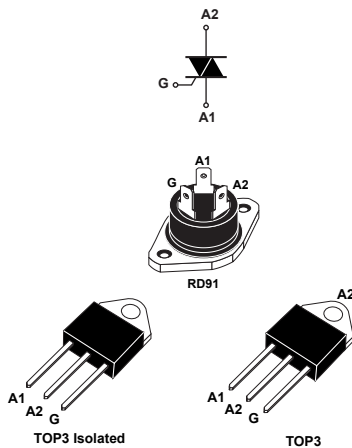


## 800 V and 600 V, 40 A standard Triacs in TOP3 and RD91 package



### Features

- High current Triac
- Low thermal resistance
- BTA40 and BTA41 UL1557 recognized components (file ref: 81734)
- RoHS (2002/95/EC) compliant packages
- UL-94, V0 flammability package resin compliance

### Applications

- On/off function in static relays, heating regulation, induction motor starting circuits
- Phase control operations in light dimmers and motor speed controllers

### Description

Available in power packages, the BTA40, BTA41 and BTB41 are suitable for general purpose AC switching.

When used with the properly dimensioned heatsink, the BTA40, BTA41 and BTB41 can enable AC switching systems up to 9 kW. Refer to ST Application Note [AN533](#) for thermal management of Triacs.

The BTA40, BTA41 and BTB41 provides an insulated tab (rated at 2500 V rms). They are recognized by UL. Representative samples of these components have been evaluated by UL and meet applicable UL requirements for UL 1557 standard (File Ref. 81734).



#### Product status link

<a href="#">BTA40</a>	RD91 package
<a href="#">BTA41</a>	TOP3 isolated package
<a href="#">BTB41</a>	TOP3 package

#### Product summary

$I_{T(RMS)}$	40 A
$V_{DRM}/V_{RRM}$	600 V to 800 V
$I_{GT}$	50 mA

# 1 Characteristics

**Table 1. Absolute maximum ratings**

Symbol	Parameters		Value	Unit	
$I_{T(RMS)}$	RMS on-state current (180° conduction angle)	BTA40, BTA41	$T_c = 80\text{ °C}$	40	A
		BTB41	$T_c = 95\text{ °C}$		
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_j$ initial = 25 °C)		$t_p = 16,7\text{ ms}$	420	A
			$t_p = 20\text{ ms}$	400	
$I^2t$	$I^2t$ value for fusing	$t_p = 10\text{ ms}$		1000	A <sup>2</sup> s
$di/dt$	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100\text{ ns}$	$f = 120\text{ Hz}$	$T_j = 125\text{ °C}$	50	A/ $\mu$ s
$V_{DSM}, V_{RSM}$	Non repetitive surge peak off-state voltage	$t_p = 20\text{ ms}$	$T_j = 25\text{ °C}$	$V_{DRM}, V_{RRM} + 100$	V
$I_{GM}$	Peak gate current	$t_p = 20\text{ }\mu$ s	$T_j = 125\text{ °C}$	8	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ °C}$	1	W
$T_{stg}$	Storage junction temperature range			-40 to +150	°C
$T_j$	Operating junction temperature range			-40 to +125	°C

**Table 2. Electrical characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified) - standard (4 quadrants)**

Symbol	Parameters	Quadrant		Values	Unit
$I_{GT}^{(1)}$	$V_D = 12\text{ V}, R_L = 33\text{ }\Omega$	I - II - III	Max.	50	mA
		IV		100	
$V_{GT}$		I - II - III	Max.	1.3	V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3\text{ k}\Omega, T_j = 125\text{ °C}$	I - II - III	Min.	0.2	V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		Max.	80	mA
$I_L$	$I_G = 1.2 I_{GT}$	I - III - IV	Max.	70	mA
		II	Max.	160	
$dV/dt^{(2)}$	$V_D = 67\% V_{DRM}$ gate open, $T_j = 125\text{ °C}$		Min.	500	V/ $\mu$ s
$(dV/dt)_c^{(2)}$	$(di/dt)_c = 20\text{ A/ms}, T_j = 125\text{ °C}$		Min.	10	V/ $\mu$ s

1. Minimum  $I_{GT}$  is guaranteed at 5 % of  $I_{GT}$  max.

2. For both polarities of A2 referenced to A1

**Table 3. Static electrical characteristics**

Symbol	Test conditions	$T_j$		Value	Unit
$V_{TM}^{(1)}$	$I_{TM} = 60\text{ A}, t_p = 380\text{ }\mu$ s	25 °C	Max.	1.55	V
$V_{TO}^{(1)}$	threshold on-state voltage	125 °C	Max.	0.85	V
$R_D^{(1)}$	Dynamic resistance	125 °C	Max.	10	m $\Omega$
$I_{DRM}/I_{RRM}$	$V_T = V_{DRM}, V_T = V_{RRM}$	25 °C	Max.	5	$\mu$ A
		125 °C		5	mA

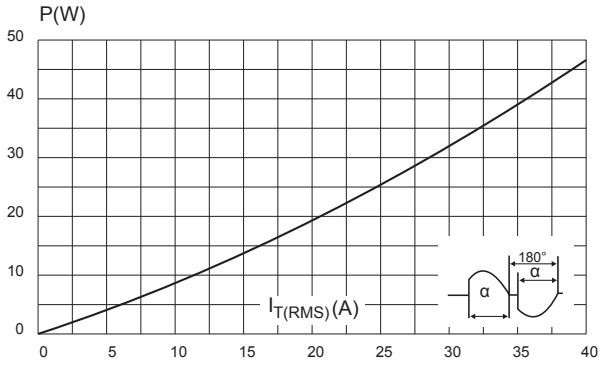
1. For both polarities of A2 referenced to A1

**Table 4. Thermal resistance**

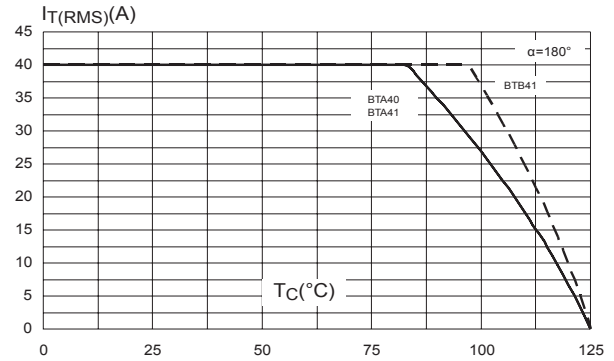
Symbol	Parameters	Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	BTA40 / BTA41	0.9
		BTB41	0.6
$R_{th(j-a)}$	Junction to ambient	BTA40 / BTA41 / BTB41	50

### 1.1 Characteristics (curves)

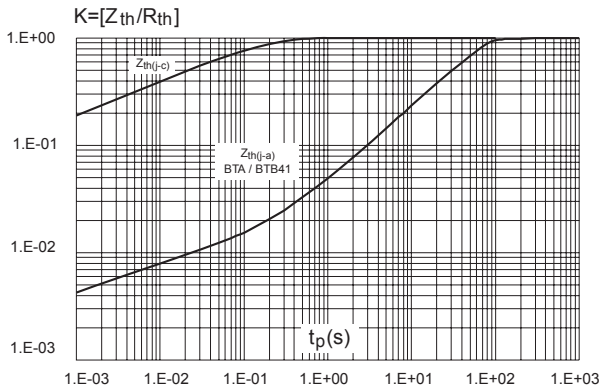
**Figure 1. Maximum power dissipation versus on-state RMS current (full cycle)**



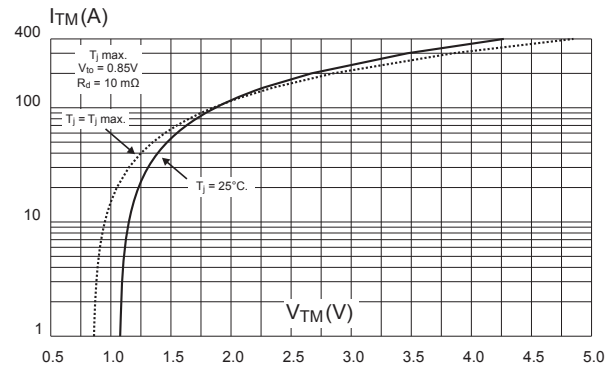
**Figure 2. RMS on-state current versus case temperature (full cycle)**



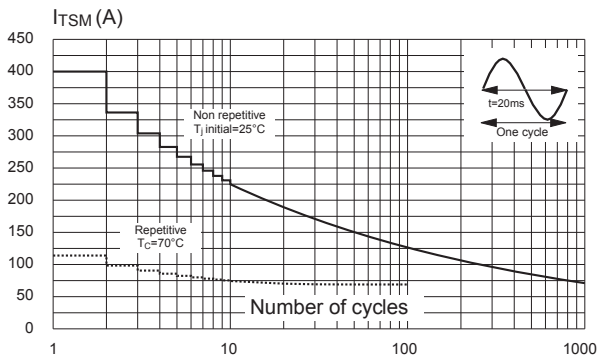
**Figure 3. Relative variation of thermal impedance versus pulse duration**



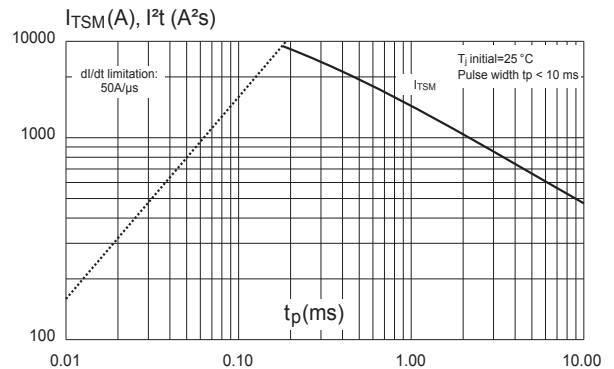
**Figure 4. On-state characteristics (maximum values)**



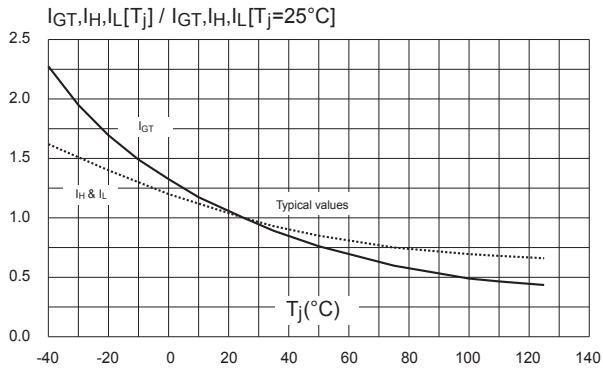
**Figure 5. Surge peak on-state current versus number of cycles**



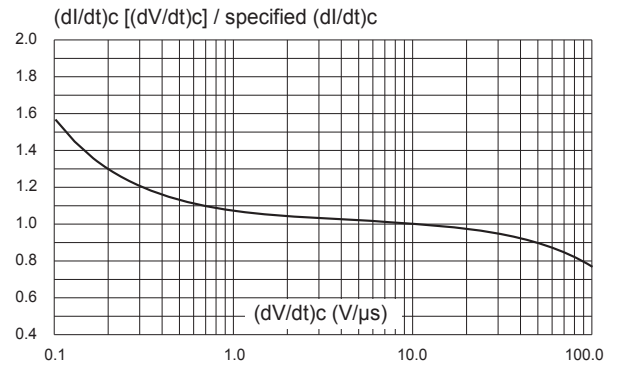
**Figure 6. Non-repetitive surge peak on-state current for a sinusoidal pulse**



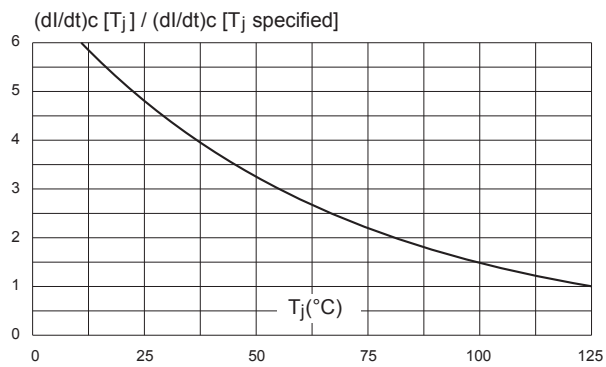
**Figure 7. Relative variation of gate trigger current, holding and latching current versus junction temperature**



**Figure 8. Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values)**



**Figure 9. Relative variation of critical rate of decrease of main current versus junction temperature (typical values)**



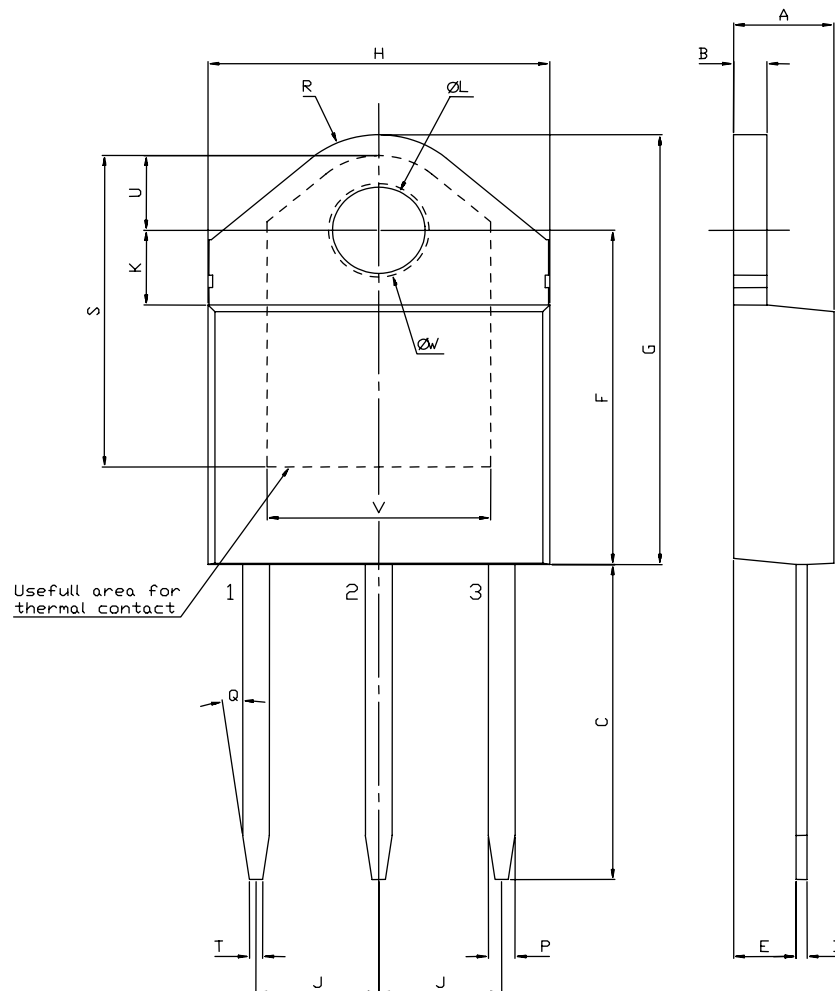
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 2.1 TOP3 insulated and non-insulated package information

- Epoxy meets UL94, V0
- Lead-free packages
- Recommended torque: 1.05 N·m (max. torque: 1.2 N·m)

Figure 10. TOP3 insulated and non-insulated package outline



**Table 5. TOP3 insulated and non-insulated mechanical data**

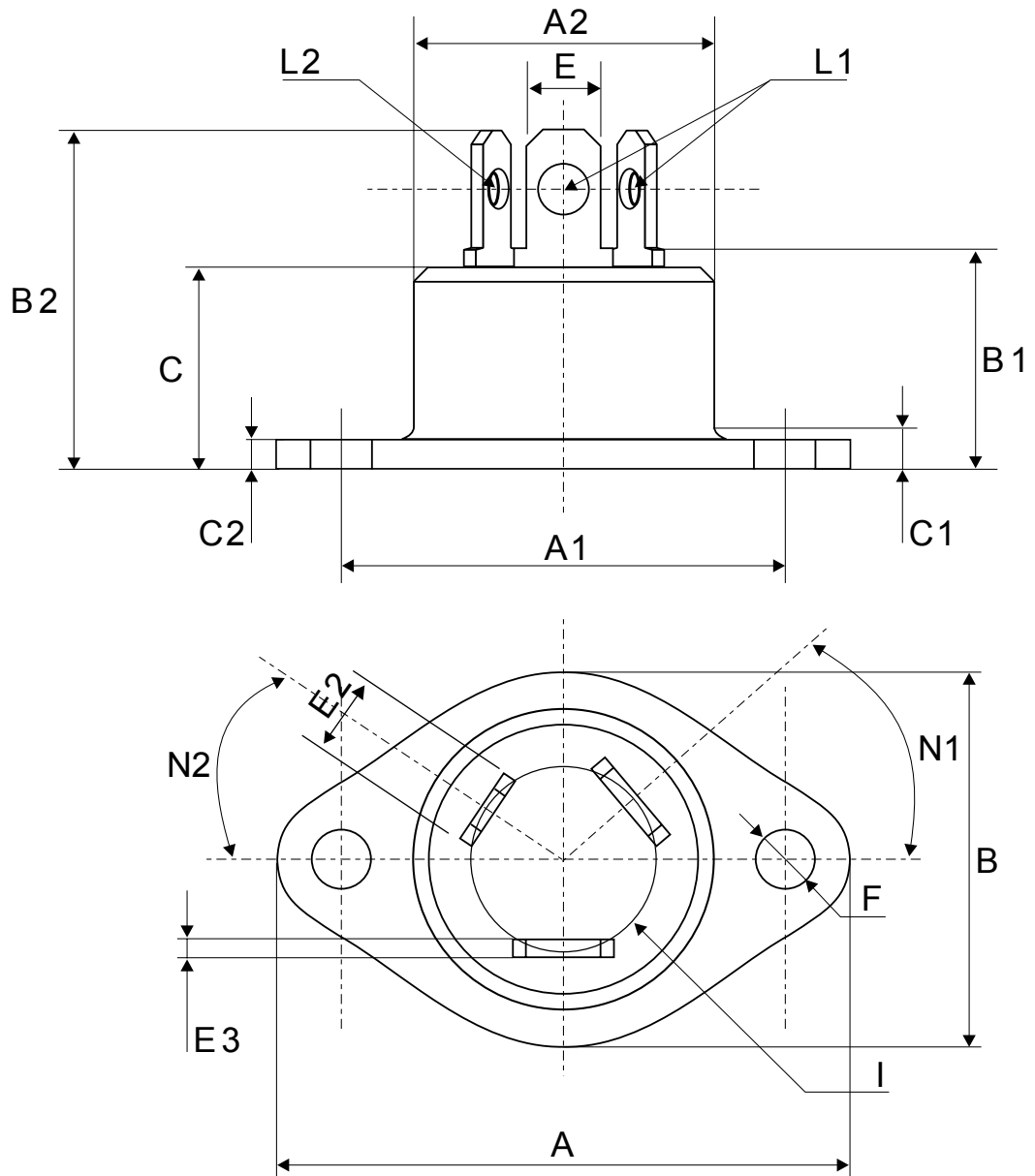
Ref.	Dimensions					
	mm			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.1732		0.1812
B	1.45		1.55	0.0570		0.0611
C	14.35		15.60	0.5649		0.6142
D	0.50		0.70	0.0196		0.0276
E	2.70		2.90	0.1062		0.1142
F	15.80		16.50	0.6220		0.6497
G	20.40		21.10	0.8031		0.8308
H	15.10		15.50	0.5944		0.6103
J	5.40		5.65	0.2125		0.2225
K	3.40		3.65	0.1338		0.1438
L	4.08		4.17	0.1606		0.1642
M	1.20		1.40	0.0472		0.0552
R		4.60			0.1811	

1. Inches given for reference only

## 2.2 RD91 package information

- Epoxy meets UL94, V0
- Cooling method: Conduction
- Recommended torque: 0.9 to 1.2 N·m

Figure 11. RD91 package outline





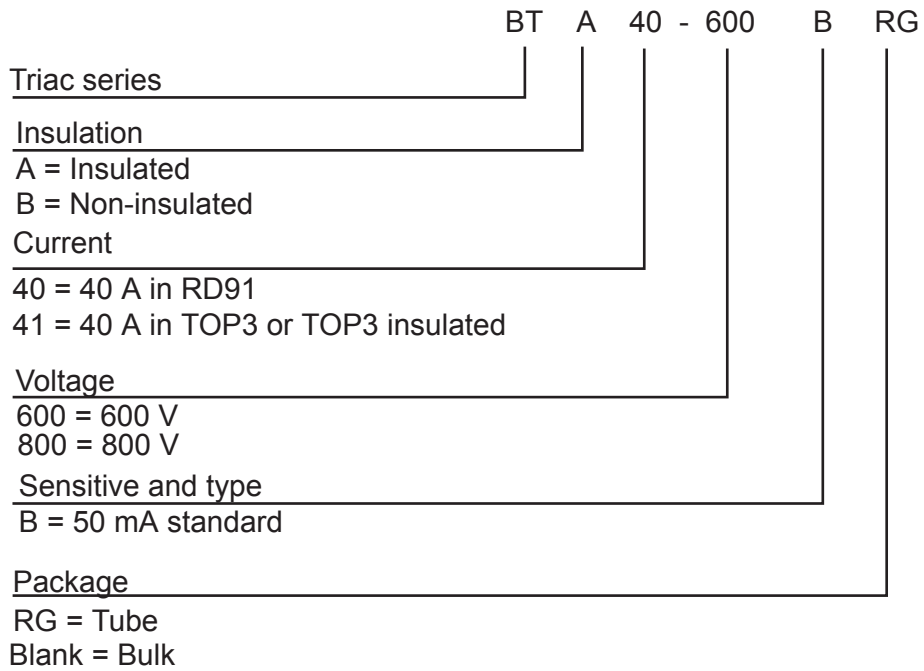
**Table 6. RD91 mechanical data**

Ref.	Dimensions					
	mm			Inches <sup>(1)</sup>		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			40.00			1.575
A1	30.10		30.30	1.185		1.193
A2			22.00			0.867
B			27.00			1.063
B1	13.50		16.50	0.531		0.650
B2			24.00			0.945
C			14.00			0.552
C1			3.50			0.138
C2	1.90		2.10	0.074		0.083
E	6.10		6.50	0.240		0.256
E2	4.80		5.20	0.188		0.205
E3	0.70		0.90	0.027		0.036
F	4.00		4.30	0.157		0.170
I	11.20		11.60	0.440		0.536
L1	3.10		3.50	0.122		0.138
L2	1.70		1.90	0.066		0.075
N1	33°		43°	33°		43°
N2	28°		38°	28°		38°

1. Inches given for reference only

### 3 Ordering information

**Figure 12. Ordering information scheme (BTA40, BTA41 and BTB-41 series)**



**Table 7. Ordering information**

Order code	Marking	Package	Weight	Base qty.	Delivery mode
BTA40-600B	BTA40600B	RD91	20 g	25	Bulk
BTA40-800B	BTA40800B	RD91	20 g	25	Bulk
BTA41-600BRG	BTA41600B	TOP3 Ins.	4.5 g	30	Tube
BTA41-800BRG	BTA41800B	TOP3 Ins.	4.5 g	30	Tube
BTB41-600BRG	BTB41600B	TOP3	4.5 g	30	Tube
BTB41-800BRG	BTB41800B	TOP3	4.5 g	30	Tube

## Revision history

**Table 8. Document revision history**

Date	Revision	Changes
Sep-2003	5	Last update.
25-Mar-2005	6	TOP3 delivery mode changed from bulk to tube.
14-Oct-2005	7	$T_c$ values for $I_T$ changed in Table 3. ECOPACK statement added.
10-Aug-2009	8	Updated Table 2 to correctly place packages. Updated Figure 2. Table 5 changed to correctly place TOP3. Updated ECOPACK statement.
02-Dec-2020	9	Updated <a href="#">Figure 6</a> and <a href="#">Figure 12</a> . Added Application section. Minor text change.
28-Jan-2021	10	Updated <a href="#">Table 1</a> and <a href="#">Table 4</a> .
24-Mar-2021	11	Updated coverimage.

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